

MLP08X.pdf.

### MOSFET Maximum Ratings T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Ratings	Units		
V <sub>DSS</sub>	Drain-to-Source Voltage		40	V	
V <sub>GS</sub>	Gate-to-Source Voltage		±12	V	
I <sub>D</sub>	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	12	Α	
	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4		
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	21.6	mJ	
	Power Dissipation		11.4	W	
P <sub>D</sub>	Derate Above 25°C		0.1	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 150	°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		13	°C/W	
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	65	°C/W	

#### Notes:

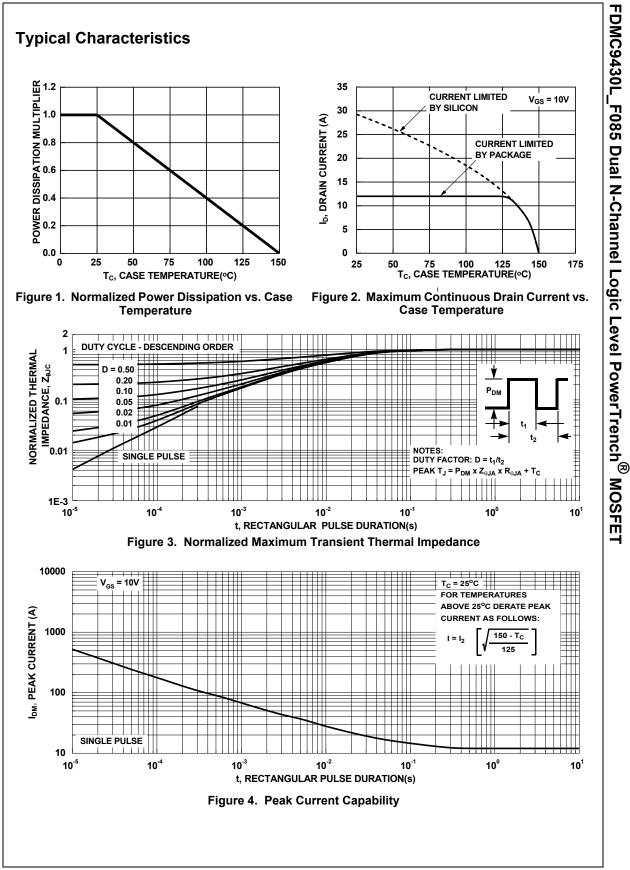
1: Current is limited by bondwire configuration.

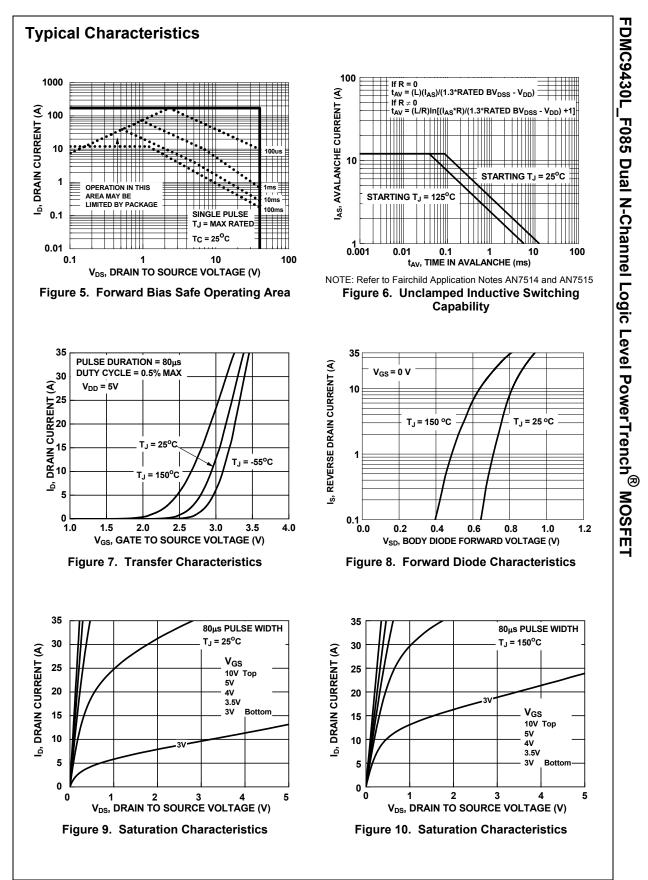
2: Starting T<sub>J</sub> = 25°C, L = 0.3mH, I<sub>AS</sub> = 12A, V<sub>DD</sub> = 40V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche. 3:  $R_{0JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta JC}$  is guaranteed by design, while  $R_{\theta JA}$  is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

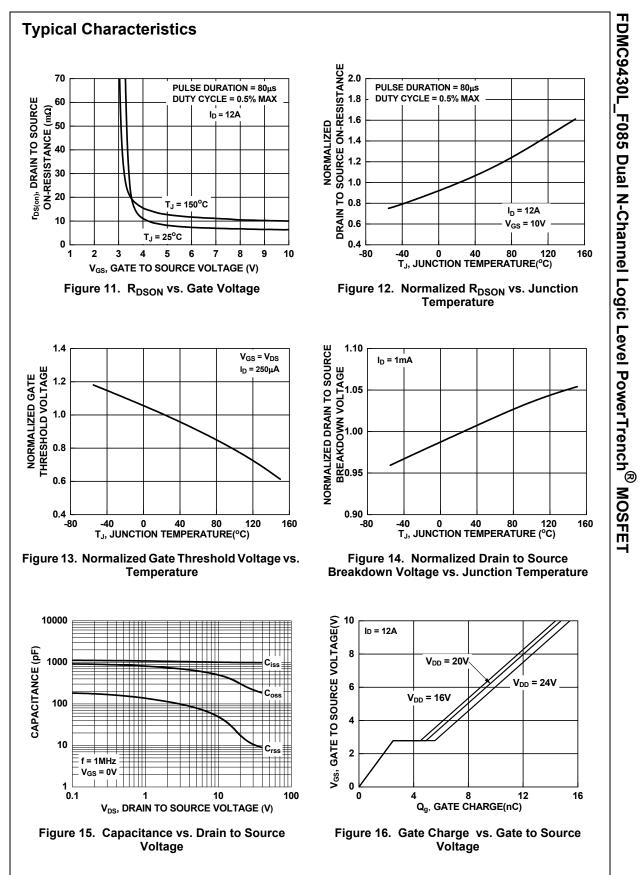
## Package Marking and Ordering Information

ſ	Device Marking	Device	Package	Reel Size	Tape Width	Quantity
	FDMC9430L	FDMC9430L_F085	Power 33	13"	12mm	3000 units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
Off Cha	racteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA,	V <sub>GS</sub> = 0V	40	-	-	V
		V <sub>DS</sub> =40V,		-	-	1	μA
DSS	Drain-to-Source Leakage Current	$V_{GS} = 0V$	$T_{\rm J} = 150^{\rm o} {\rm C} \; ({\rm Note} \; 4)$	-	-	0.2	mA
GSS	Gate-to-Source Leakage Current	$V_{GS} = \pm 12V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> ,	ь = 250uA	1	1.8	3	V
• GS(III)		$I_{\rm D} = 10$ A, V <sub>C</sub>		-	8.9	11.5	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = 12A,		-	6.3	8.0	mΩ
03(01)		V <sub>GS</sub> = 10V	$T_{J} = 150^{\circ}C$ (Note 4)	-	10.2	13.0	mΩ
	c Characteristics				984	-	pF
C <sub>iss</sub>	Output Capacitance	− V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, _ f = 1MHz		-	315	-	pr pF
C <sub>oss</sub> C <sub>rss</sub>	Reverse Transfer Capacitance				18	_	pr
R <sub>g</sub>	Gate Resistance	V <sub>GS</sub> = 0.5V, f = 1MHz		_	1.1	-	Ω
	Total Gate Charge	$V_{GS} = 0$ to 1	e) (	-	15	22	nC
Q <sub>g(ToT)</sub> Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS} = 0$ to 1		-	0.9	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge			-	2.6	-	nC
∽ <sub>gs</sub> Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	2.1	-	nC
	ng Characteristics				-	13	ns
t <sub>on</sub>	Turn-On Delay			-	- 7	-	ns
t <sub>d(on)</sub> t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 20V,	L = 12A	-	2	_	ns
r t <sub>d(off)</sub>	Turn-Off Delay	$V_{\rm DD} = 200,$ $V_{\rm GS} = 10V,$	$R_{CEN} = 6\Omega$	-	17	-	ns
t <sub>f</sub>	Fall Time		GEN	-	2	-	ns
t <sub>off</sub>	Turn-Off Time	_	-	-	-	28	ns
	ource Diode Characteristics						
V <sub>SD</sub>	Source-to-Drain Diode Voltage	I <sub>SD</sub> = 12A, \		-	-	1.2	V
▼SD		I <sub>SD</sub> = 6A, V <sub>0</sub>	<sub>GS</sub> = 0V	-	-	1.1	V
t <sub>rr</sub>	Reverse-Recovery Time	V <sub>DD</sub> = 32V, I <sub>F</sub> = 12A,		-	32	48	ns
Q <sub>rr</sub>	Reverse-Recovery Charge	dl <sub>SD</sub> /dt = 100A/µs		-	16	24	nC









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